

CP188-2N2919 NPN - Low Noise Transistor Die

The CP188-2N2919 is a silicon NPN transistor designed for low noise amplifier applications.

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		MECHANICA	L SPECIFICAT	IONS:	
		Die Size		14.6 x 14.6 MILS	
		Die Thicknes	S	9.0 MILS	
		Base Bonding	g Pad Size	3.9 x 3.9 MILS	
			ing Pad Size	5.5 x 5.5 MILS	
Back S Scribe Wafer		Top Side Met	alization	AI – 30,000Å	
		Back Side Metalization		Au-As – 18,000Å	
		Scribe Alley Width		2.4 MILS	
		Wafer Diameter		4 INCHES	
		Gross Die Pe	er Wafer	54,599	
	RATINGS: (T _A =25°C)		SYMBOL		UNITS
	Collector-Base Voltage			60	V
Collector-Em	Collector-Emitter Voltage			60	V
Emitter-Base Voltage			VEBO	6.0	V
Continuous	Continuous Collector Current			30	mA
Operating and Storage Junction Temperature			T _J , T _{stg}	-65 to +150	°C
SYMBOL		S	MIN	MAX 2.0	UNITS
I _{CBO}	V _{CB} =45V			2.0	nA nA
I _{CEO}	V _{CE} =5.0V			2.0	
I _{EBO}	V _{EB} =5.0V		00	2.0	nA
BV _{CBO}	I _C =10μΑ		60		V
BVCEO	I _C =10mA		60		V
BV _{EBO}	I _E =10μA		6.0	0.05	V
VCE(SAT)	I _C =1.0mA, I _B =100			0.35	V
V _{BE(ON)}	V _{CE} =5.0V, I _C =100			0.70	V
hFE	V _{CE} =5.0V, Ι _C =10μΑ		60	240	
hFE	V _{CE} =5.0V, I _C =100µA		100		
hFE	V _{CE} =5.0V, I _C =1.0	mA	150		
fT	V _{CE} =5.0V, I _C =500µA, f=20MHz		60		MHz
Cob	V _{CB} =5.0V, I _E =0, f	=140kHz		6.0	pF
NF	V _{CE} =5.0V, I _C =10µ	ıA, R _S =10kΩ,			
	f=1.0kHz, BW=200	Hz		4.0	dB

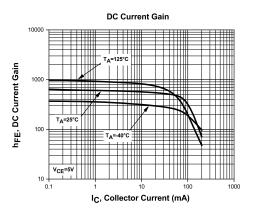
MECHANICAL SPECIFICATIONS

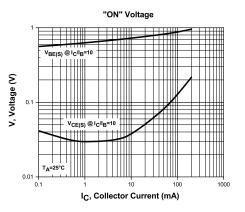
R0 (20-May 2019)

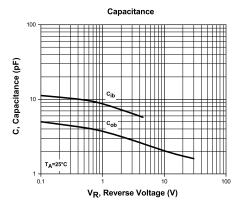
CP188-2N2919 Typical Electrical Characteristics



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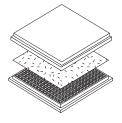




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BARE DIE PACKING OPTIONS



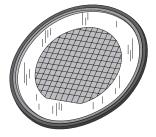


BARE DIE IN TRAY (WAFFLE) PACK

- CT: Singulated die in tray (waffle) pack. (example: CP211-PART NUMBER-CT)
- CM: Singulated die in tray (waffle) pack 100% visually inspected as per MIL-STD-750, (method 2072 transistors, method 2073 diodes). (example: CP211-<u>PART NUMBER</u>-CM)

UNSAWN WAFER

WN: Full wafer, unsawn, 100% tested with reject die inked. (example: CP211-PART NUMBER-WN)



SAWN WAFER ON PLASTIC RING

WR: Full wafer, sawn and mounted on plastic ring, 100% tested with reject die inked. (example: CP211-PART NUMBER-WR)

Please note: Sawn Wafer on Metal Frame (WS) is possible as a special order. Please contact your Central Sales Representative at 631-435-1110.



Visit the Central website for a complete listing of specifications: www.centralsemi.com/bdspecs

OUTSTANDING SUPPORT AND SUPERIOR SERVICES

PRODUCT SUPPORT

Central's operations team provides the highest level of support to insure product is delivered on-time.

- Supply management (Customer portals)
- Inventory bonding
- Consolidated shipping options

DESIGNER SUPPORT/SERVICES

Central's applications engineering team is ready to discuss your design challenges. Just ask.

- Free guick ship samples (2nd day air)
- Online technical data and parametric search
- SPICE models
- Custom electrical curves
- · Environmental regulation compliance
- Customer specific screening
- · Up-screening capabilities

· Custom product packing

Custom bar coding for shipments

- Special wafer diffusions
- PbSn plating options
- Package details
- Application notes
- · Application and design sample kits
- · Custom product and package development

REQUESTING PRODUCT PLATING

- If requesting Tin/Lead plated devices, add the suffix "TIN/LEAD" to the part number when 1. ordering (example: 2N2222A TIN/LEAD).
- 2. If requesting Lead (Pb) Free plated devices, add the suffix " PBFREE" to the part number when ordering (example: 2N2222A PBFREE).

CONTACT US

Corporate Headquarters & Customer Support Team

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Worldwide Distributors: www.centralsemi.com/wwdistributors

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http://www.centralsemi.com

Product End of Life Notification

PDN ID:	PDN01147
Notification Date:	3/13/20
Last Buy Date:	9/13/20
Last Shipment Date	3/13/21

Summary: The CP188 and CP588 wafer processes are being discontinued and are now classified as End of Life (EOL). The replacement wafer processes are the CP388X and CP788X, respectively.

Although Central Semiconductor Corp. makes every effort to continue to produce devices that have been proclaimed EOL (End of Life) by other manufacturers, it is an accepted industry practice to discontinue certain devices when customer demand falls below a minimum level of sustainability. Accordingly, the following product(s) have been transitioned to End of Life status as part of Central's ongoing Product Management Process. Any replacement products are noted below. The effective date for placing last purchase orders will be six (6) months from the date of this notice and twelve (12) months from the notice date for final shipments, and minimum order quantities may apply. The last purchase and shipment dates may be extended if inventory is available.

Central Part Number	Replacement
CP188-BC107A-CT	CP388X-BC107A-CT
CP188-BC108-CT	CP388X-BC108-CT
CP188-BC546B-CT	CP388X-BC546B-CT
CP188-BC546B-WR	CP388X-BC546B-WR
CP188-2N2919-CT	CP388X-2N2919-CT
CP188-2N5088-CT	CP388X-2N5088-CT
CP588-BCY70-WN	CP788X-BCY70-WN
CP588-BC556B-CT	CP788X-BC556B-CT
CP588-BC556B-WN	CP788X-BC556B-WN
CP588-BC556B-WR	CP788X-BC556B-WR
CP588-HBC556B-CM	CP788X-HBC556B-CM
CP588-2N2605-CT	CP788X-2N2605-CT
CP588-2N2605-WN	CP788X-2N2605-WN

Central would be happy to assist you by providing additional information or technical data to help locate an alternate source if we have no replacement available. Please email your requests to engineering@centralsemi.com.

DISCLAIMER: This End of Life (EOL) notification is in accordance with JEDEC standard JESD48 - Product Discontinuance. Central Semiconductor Corp. will make every effort to offer life-time buy (LTB) opportunities and/or offer replacement devices to existing customers for discontinued devices, however, one or both may not be possible for all devices. Please contact your local Central Semiconductor sales representative for LTB opportunities/additional information.